



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Richard W. Wensel

**Serial No.:** 10/600,149

**Filed:** June 19, 2003

**For:** SEMICONDUCTOR DIE WITH  
ATTACHED HEAT SINK AND  
TRANSFER MOLD

**Confirmation No.:** 6258

**Examiner:** N. Ha

**Group Art Unit:** 2814

**Attorney Docket No.:** 2269-3061.8US  
(96-0893.07/US)

**NOTICE OF EXPRESS MAILING**

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**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 or PTO/SB/08 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an

admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicant herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

<u>U.S. Patent Documents</u>		
<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 5,637,913	06/10/1997	Kajihara et al.
US - 6,083,775	07/04/2000	Huang et al.
US - 6,242,287 B1	06/05/2001	Aoki et al.
US - 6,295,221 B1	09/25/2001	Iwasaki et al.
US - 2001/0028544 A1	10/11/2001	Sano et al.
US - 2001/0050846 A1	12/13/2001	Cho
US - 6,388,984 B2	05/14/2002	Kitaura et al.
US - 6,404,643 B1	06/11/2002	Chung
US - 6,462,273 B1	10/08/2002	Corisis et al.
US - RE38,068 E	04/08/2003	Stoll et al.
US - 6,573,567 B1	06/03/2003	Nishizawa et al.
US - 6,821,822 B1	11/23/2004	Sato

Applicant offers to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

Serial No. 10/600,149

This Supplemental Information Disclosure Statement is filed concurrently with an RCE in the above-identified application, and therefore no additional fee is due.

Respectfully submitted,



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Date: November 14, 2005

JRD/dlm:lmh

Enclosures: Form PTO-1449 or PTO/SB/08  
Copy of documents cited

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PTO/SB/08A (10-01)

Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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Substitute for form 1449A/PTO

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(use as many sheets as necessary)

Sheet 1 of 1

**Complete if Known**

Application Number	10/600,149
Filing Date	June 19, 2003
First Named Inventor	Richard W. Wensel
Group Art Unit	2814
Examiner Name	N. Ha
Attorney Docket Number	2269-3061.8US (96-0893.07/US)

**U.S. PATENT DOCUMENTS**

Examiner Initials *	Cite No. <sup>1</sup>	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number - Kind Code <sup>2</sup> (if known)			
		US-5,637,913	06/10/1997	Kajihara et al.	
		US- 6,083,775	07/04/2000	Huang et al.	
		US- 6,242,287 B1	06/05/2001	Aoki et al.	
		US- 6,295,221 B1	09/25/2001	Iwasaki et al.	
		US- 2001/0028544 A1	10/11/2001	Sano et al.	
		US- 2001/0050846 A1	12/13/2001	Cho	
		US- 6,388,984 B2	05/14/2002	Kitaura et al.	
		US- 6,404,643 B1	06/11/2002	Chung	
		US- 6,462,273 B1	10/08/2002	Corisis et al.	
		US- RE38,068 E	04/08/2003	Stoll et al.	
		US- 6,573,567 B1	06/03/2003	Nishizawa et al.	
		US- 6,821,822 B1	11/23/2004	Sato	
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**FOREIGN PATENT DOCUMENTS**

Examiner Initials *	Cite No. <sup>1</sup>	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
		Country Code <sup>3</sup> - Number <sup>4</sup> - Kind Code <sup>5</sup> (if known)				

Examiner  
SignatureDate  
Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.

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